

10-22-1998

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**HARIANTO WONG AND  
JOHN LEONARD SUDIJONO**

2. Name and address of receiving party(ies):

Name: **Chartered Semiconductor Manufacturing Ltd.**

Internal Address:

Street Address:

**60 Woodlands Industrial Park D  
Street 2  
City: Singapore Zip: 738406  
Country: Singapore**Additional name(s) or conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance



Assignment



Merger



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Execution Date: **9/20/98**Additional name(s) & address(es) attached? Yes ☐ No ☒4. Application number(s) or patent number(s): **09170734**If this document is being filed together with a new application, the execution date of the application is: **9/20/98, 10/1/98**

A. Patent Application No(s)

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **GEORGE O. SAILE**

Internal Address: \_\_\_\_\_

Street Address: **20 MCINTOSH DRIVE**City: **POUGHKEEPSIE** State: **NY** ZIP: **12603**6. Total no. of applications and patents involved: **1**7. Total fee (37 CFR 3.41): **\$ 40.00**

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**October 9, 1998**

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Total number of pages comprising cover sheet: **3**PATENT  
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### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR:

HARIANTO WONG  
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#### ASSIGNEE:

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60 Woodlands Industrial Park D  
Street 2  
Singapore 738406  
Singapore  
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- ☒ the entire right, title and interest  
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in and to any and all improvements which are disclosed in the invention entitled:

A Method To Prevent Dishing In Damascene CMP Process

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith
- (b) ☒ U.S. patent application executed on 9/20/98 and 10/1/98
- (c) ☐ U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_
- (d) ☐ U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
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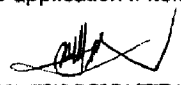
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